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Examiner: M. S. Lebentritt

For: Method and Apparatus for Treating Low K Dielectric Layers to Reduce Diffusion

CERTIFICATE UNDER 37 CFR 1.10

I hereby certify that this correspondence and the documents referred to as attached therein are being deposited on May 8, 2003 with the United States Postal Service in an envelope as "Express Mail Post Office to Addressee," mailing label No. EV349850709US addressed to: Mail Stop 313(c), Commissioner for Patents, P.O. Box 1450 Alexandria, VA 22313-1450.

May 8, 2003  
Date

Bn. K. G. A.  
Signature

Prior to examining the above-referenced application, the Applicants request the application be amended as follows.

Please replace paragraph [0001] of the specification with the following paragraph:

[0001] This application claims priority to United States provisional patent application serial number 60/218,407, filed July 14, 2000, which is herein incorporated by reference. This application is related to co-pending United States Patent Application No. 09/336,525 (AMAT/3577.X1), filed on June 18, 1999, co-pending United States Patent Application No. 09/657,392 (AMAT/4479), filed on September 8, 2000, and co-